

SSH22N50-VB Datasheet

N-Channel 600 V (D-S) Super Junction MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	600					
R _{DS(on)} (Ω) at 25 °C	$V_{GS} = 10 V$	0.19				
Q _g max. (nC)	106					
Q _{gs} (nC)	14					
Q _{gd} (nC)	33					
Configuration	Single					

FEATURES

- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM) $R_{on} \times Q_g$
- Low input capacitance (C_{iss})
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switch mode power supplies (SMPS)

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G D S	D (TAB)
	S N-Channel MOSFET

= 25 °C, unless otherwis	se noted)			
PARAMETER			UNIT	
Drain-Source Voltage			v	
Gate-Source Voltage			v	
$T_{\rm C} = 25 ^{\circ}{\rm C}$	- I _D -	20	А	
$T_{\rm C} = 100 ^{\circ}{\rm C}$		13		
Pulsed Drain Current ^a				
Linear Derating Factor		1.7	W/°C	
Single Pulse Avalanche Energy ^b			mJ	
Maximum Power Dissipation			W	
Operating Junction and Storage Temperature Range			°C	
T _J = 125 °C	d\//dt	37	V/ns	
Reverse Diode dV/dt ^d			v/ns	
for 10 s		300	°C	
	V_{GS} at 10 V $T_{C} = 25 °C$ $T_{C} = 100 °C$ $T_{J} = 125 °C$	$\begin{tabular}{ c c c c c } & SYMBOL & & & & & & & & & & & & & & & & & & &$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD} = 50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5.1 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS

COMPLIANT

HALOGEN FREE



INGS							
SYMBOL	TYP.		MAX.		UNIT		
R _{thJA}	- 62						
R _{thJC}	-		0.5			°C/W	
·							
unless otherwi	se noted)						
SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
I	1						1
V _{DS}	V _{GS} :	= 0 V, I _D =	250 µA	600	-	-	V
$\Delta V_{DS}/T_{J}$				-	0.67	-	V/°C
V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V
1	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
IGSS		V _{GS} = ± 30 V		-	-	± 1	μA
	V _{DS} =	= 520 V, V _G	_{is} = 0 V	-	-	1	
IDSS	V _{DS} = 520 \			-	-	500	μA
R _{DS(on)}	V _{GS} = 10 V	I	_D = 11 A	-	0.19	-	Ω
9 _{fs}	V _{DS}	= 30 V, I _D :	= 11 A	-	7.0	-	S
-							
C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2322	-	pF	
C _{oss}			-	105	-		
C _{rss}			-	4	-		
C _{o(er)}	$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V		-	84	-		
C _{o(tr)}			-	293	-		
Qg	V _{GS} = 10 V I _D = 11 A, V _{DS} = 520 V		-	71	106	nC	
Q _{gs}			-	14	-		
Q _{gd}			-	33	-		
t _{d(on)}		· · · · · · · · · · · · · · · · · · ·		-	22	44	
t _r				-	34	68	
t _{d(off)}	V_{GS} = 10 V, R_g = 9.1 Ω		-	68	102	- ns	
t _f			-	42	84		
R _g	f = 1 MHz, open drain		-	0.78	-	Ω	
cs							
I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	A	
I _{SM}			-	-	53		
	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	0.9	1.2	V	
V _{SD}							
	-			-	160	-	ns
V _{SD} t _{rr} Q _{rr}	T _J = 2	5 °C, Ι _F = Ι _ξ 100 Α/μs, '	_S = 11 A,	-	160 1.2	-	ns µC
	RthJA RthJC SYMBOL VDS ΔVDs/TJ VGS(th) IGSS IDSS RDS(on) 9fs Ciss Coss Crss Co(er) Co(er) Qg Qgd td(on) tr tf Rg ics Is Is	$\begin{tabular}{ c c c c } \hline SYMBOL & TYP. \\ \hline $R_{th,JA} & - \\ \hline $R_{th,JC} & - \\ \hline $R_{th,JC} & - \\ \hline $SYMBOL & TES \\ \hline $V_{DS} & V_{GS} & \\ \hline $V_{DS} & V_{GS} & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS}/T_J & Referenc & \\ \hline $V_{DS} & V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} & \\ \hline $V_{DS} & S^{T} & \\ \hline $V_{DS} $	SYMBOLTYP. R_{thJA} - R_{thJC} -unless otherwise noted)SYMBOLTEST CONDIT V_{DS} $V_{GS} = 0 V, I_D =$ $\Delta V_{DS}/T_J$ Reference to 25 °C, $V_{GS}(th)$ $V_{DS} = V_{GS}, I_D =$ $V_{GS}(th)$ $V_{DS} = V_{GS}, I_D =$ $V_{GS}(th)$ $V_{DS} = 520 V, V_G = 10 V$ I_{DSS} $V_{DS} = 520 V, V_{GS} = 0 V$ I_{DSS} $V_{DS} = 10 V$ I_{SS} $V_{GS} = 10 V$ I_{Coss} $V_{DS} = 0 V$ to 520 V, I_D Q_{g} $V_{DS} = 0 V$ to 520 V, I_D Q_{g} $V_{GS} = 10 V$ $I_{D} = 11$ Q_{gs} $I_{d(off)}$ $V_{GS} = 10 V$ I_{f} $V_{DD} = 520 V, I_D$ $V_{GS} = 10 V, R_{g}$ I_{S} MOSFET symbolshowing theintegral reverse $P - n$ junction diode	$\begin{tabular}{ c c c c } \hline SYMBOL & TYP. & MAX. \\ \hline $R_{th,JA}$ & - & 62 \\ \hline $R_{th,JC}$ & - & 0.5 \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline \hline $SYMBOL & TEST CONDITIONS \\ \hline V_{DS} & $V_{GS} = 0 V, I_D = 250 \ \mu A \\ \hline $\Delta V_{DS}/T_J$ & Reference to 25 °C, I_D = 1 mA \\ \hline $V_{GS}(th)$ & $V_{DS} = V_{GS}, I_D = 250 \ \mu A \\ \hline $V_{GS} = \pm 20 \ V$ \\ \hline I_{GSS} & $V_{GS} = \pm 20 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V$ \\ \hline $V_{DS} = 100 \ V$ \\ \hline $V_{DS} = 100 \ V$ \\ \hline C_{coss} & $V_{DS} = 100 \ V$ \\ \hline C_{coss} & $V_{DS} = 100 \ V$ \\ \hline C_{coss} & $V_{DS} = 100 \ V$ \\ \hline C_{cotr} & $V_{DS} = 0 \ V$ to 520 \ V$, $V_{GS} = 0 \ V$ \\ \hline $C_{o(tr)$ & $V_{DS} = 0 \ V$ to 520 \ V$, $V_{GS} = 0 \ V$ \\ \hline $C_{o(tr)$ & $V_{DS} = 10 \ V$ \\ \hline C_{agd} & $V_{CS} = 10 \ V$ \\ \hline C_{agd} & $V_{CS} = 10 \ V$ \\ \hline $C_{p} = 520 \ V$, $V_{DS} = 520 \ V$ \\ \hline C_{qgd} & $V_{DS} = 10 \ V$ \\ \hline $C_{p} = 520 \ V$, $V_{p} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$, $V_{DS} = 520 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 520 \ V$, $V_{GS} = 0 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 520 \ V$, $V_{DS} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$, $V_{DS} = 11 \ A$ \\ \hline $V_{DD} = 520 \ V$, $V_{B} = 11 \ A$ \\ \hline $V_{DS} = 10 \ V$, $R_{g} = 9.1 \ \Omega$ \\ \hline T_{t} \\ \hline R_{g} & $f = 1 \ MHz$, $open drain \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a(tr)$ & $V_{DS} = 10 \ V$ \\ \hline $C_{a($	$\begin{tabular}{ c c c c c } \hline SYMBOL & TYP. & MAX. \\ \hline R_{thJA} & - & 62 \\ \hline R_{thJC} & - & 0.5 \\ \hline \hline $Unless otherwise noted] \\ \hline $SYMBOL & TEST CONDITIONS & MIN. \\ \hline V_{DS} & $V_{GS} = 0 V, I_D = 250 \ \mu A & 600 \\ \hline $\Delta V_{DS}/T_J$ & Reference to 25 °C, I_D = 1 mA & - \\ \hline $V_{GS}(th)$ & $V_{DS} = V_{GS}, I_D = 250 \ \mu A & 2 \\ \hline $V_{GS} = 10 V$ & $V_{GS} = 250 \ \mu A & 2 \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & T_J = 125 \ ^{\circ}C & - \\ \hline $R_{DS}(on)$ & $V_{GS} = 10 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V, T_J = 125 \ ^{\circ}C & - \\ \hline $R_{DS}(on)$ & $V_{GS} = 10 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 30 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V$ & $V_{DS} = 100 \ V$ $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 100 \ V, I_D = 11 \ A $- \\ \hline $V_{DS} = 0 \ V$ to 520 \ V, V_{GS} = 0 \ V$ $- \\ \hline $V_{DS} = 0 \ V$ to 520 \ V, V_{GS} = 0 \ V$ $- \\ \hline $V_{DS} = 10 \ V$ $V_{DS} = 520 \ V$ $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{DS} = 10 \ V$ \ A $- \\ \hline $V_{Co(tr)}$ & $- \\ \hline $V_{DS} = 10 \ V$ \ N_{SS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $A \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = 10 \ V$ \ A $- \\ \hline $V_{CS} = $	$\begin{tabular}{ c c c c c } \hline $YMBOL & TYP. & MAX. \\ \hline $R_{th,JA} & - & 62 \\ \hline $R_{th,JC} & - & 0.5 \\ \hline $Unless otherwise noted] \\ \hline $YMBOL & TEST CONDITIONS & MIN. $TYP. \\ \hline $V_{DS} & V_{GS} = 0 V, I_D = 250 \ \mu A & - & 0.67 \\ \hline $V_{DS}/T_J & Reference to 25 \ ^{\circ}C, I_D = 1 \ m A & - & 0.67 \\ \hline $V_{GS}(th) & V_{DS} = V_{GS}, I_D = 250 \ \mu A & 2 & - \\ \hline $V_{GS}(th) & V_{DS} = 520 \ V, C_{SS} = 420 \ V & - & - \\ \hline $V_{GS} = 520 \ V, V_{GS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{GS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V & - & - \\ \hline $V_{DS} = 520 \ V, V_{CS} = 0 \ V, T_J = 125 \ ^{\circ}C & - & - \\ \hline $R_{DS}(on) & V_{GS} = 10 \ V & I_D = 11 \ A & - & 0.19 \\ \hline $g_{fs} & V_{DS} = 30 \ V, I_D = 11 \ A & - & 0.19 \\ \hline $g_{fs} & V_{DS} = 100 \ V, f = 1 \ MHz & - & 7.0 \\ \hline \hline $C_{res} & V_{DS} = 10 \ V, OS = 0 \ V \ V_{DS} = 100 \ V, f = 1 \ MHz & - & 4 \\ \hline $C_{o}(er) $V_{CS} = 10 \ V \ V_{DS} = 0 \ V \ V_{DS} = 520 \ V, V_{GS} = 0 \ V \\ \hline $c_{res} & V_{CS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ 14 \\ \hline $Q_{gd} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ 14 \\ \hline $Q_{Qg} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ 14 \\ \hline $C_{o}(er) $V_{DD} = 520 \ V, I_D = 11 \ A, V_{DS} = 520 \ V & - \ 14 \\ \hline $Q_{Qg} & V_{GS} = 10 \ V, R_{g} = 9.1 \ \Omega & - \ 14 \\ \hline $Q_{2} \ R_{g} & f = 1 \ MHz, \ $open \ drain \ $-$ \ 0.78 \\ \hline c \\ \hline \hline $I_{SM} & MOSFET \ symbol $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $p - n junction diode $showing the $integral reverse $$	$\begin{tabular}{ c c c c c c } \hline SYMBOL & TYP. & MAX. & UNIT \\ \hline $R_{th,JC} & - & 0.5 & \end{tabular} tabul$

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

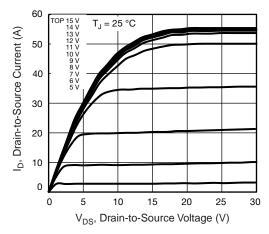


Fig. 1 - Typical Output Characteristics



Fig. 2 - Typical Output Characteristics

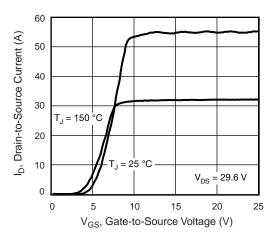


Fig. 3 - Typical Transfer Characteristics

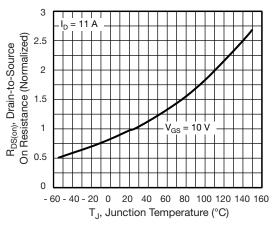


Fig. 4 - Normalized On-Resistance vs. Temperature

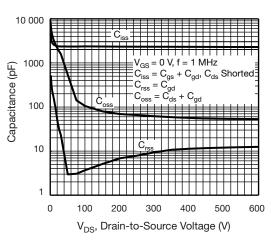


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

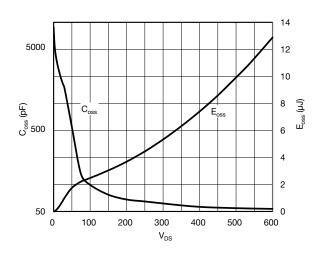


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



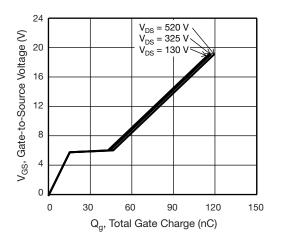


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

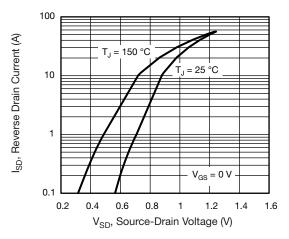


Fig. 8 - Typical Source-Drain Diode Forward Voltage

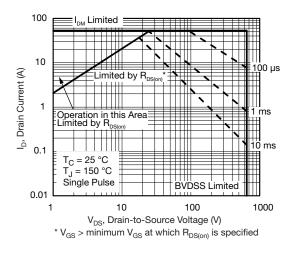


Fig. 9 - Maximum Safe Operating Area

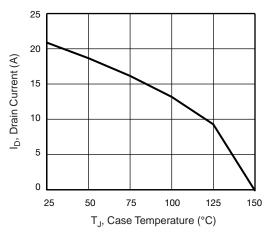


Fig. 10 - Maximum Drain Current vs. Case Temperature



Fig. 11 - Temperature vs. Drain-to-Source Voltage





Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case



Fig. 13 - Switching Time Test Circuit



Fig. 14 - Switching Time Waveforms

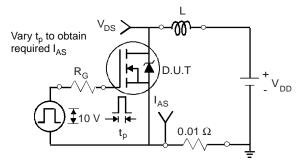


Fig. 15 - Unclamped Inductive Test Circuit

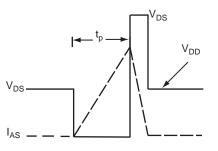


Fig. 16 - Unclamped Inductive Waveforms

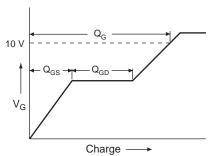
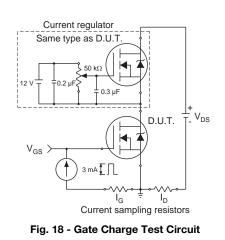
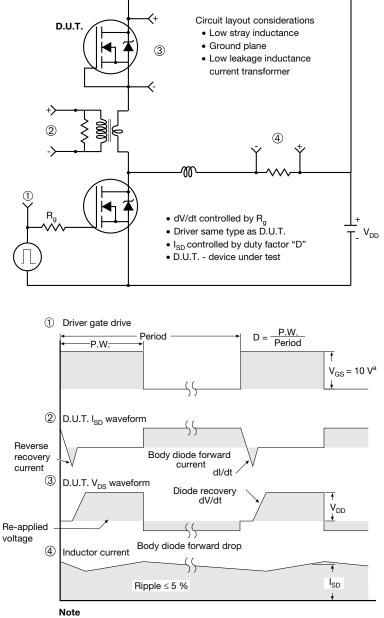


Fig. 17 - Basic Gate Charge Waveform





Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel



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All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

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